

Computer Engineering Co-op

Electrical Engineering Co-op

Industrial Engineering Co-op

Mechanical Engineering Co-op

Mechanical Engineering Graduating Student

Microelectronic Engineering Co-op

# John Doe

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10 Smith Street  
City, State, Zip  
555- 123-4567 (cell)

1 John Street  
Rochester, NY 14623

**OBJECTIVE** To apply my knowledge of Electrical Engineering principles through co-op employment.  
Available for a 3-6 month period beginning late November 2012.

**EDUCATION** **ROCHESTER INSTITUTE OF TECHNOLOGY**, Rochester, NY  
Bachelor of Science in Electrical Engineering, expected May 2015  
GPA: 2.89/4.00

<b>Courses:</b>	Digital Systems
Circuit Analysis I with Lab	Engineering Math
Circuit Analysis II	Intro Prog / C & Matlab
Technical Programming I with Lab	Intro to Semiconductor Devices
Electromagnetic Fields I	Electronics I
Electromagnetic Fields II with Lab	Linear Systems I & II

**SKILLS** **Software:** C Programming, C++ Programming, MATLAB, Quartus, Altera, Microsoft Excel and Assembly Language  
**Hardware:** Oscilloscope, Power Quality Analyzer, Digital Multimeter, Signal Generator, PSpice, Network Analyzer, TI MSP430 Microcontroller Platform and Circuit Board Etching

**PROJECTS/LABS** **Technical Programming I Lab**  
Object-oriented programming through C++ was used to develop software solutions for engineering and scientific applications.

**Electromagnetic Fields II Lab**  
An HP8752 network analyzer was used to observe the effects of various loads on the voltage and current within transmission lines.

**Microcomputer Systems Lab**  
A TI MSP430 16-bit microcontroller platform was programmed in assembly language to carry out specific functions.

**Circuit Analysis I Lab**  
Resistor circuits and RC circuits were constructed and tested. Waveforms and voltages were measured and compared to the circuit.

**Digital Systems Lab**  
Various digital logic circuits were analyzed schematically and then tested on hardware using an Altera hardware board.

<b>MANUFACTURING EXPERIENCE</b>	<b>Smith Packaging Company, City, State</b>	<b>Summer 2012</b>
	<b>Assembler</b>	
	Assembled plastic parts for medical and commercial applications.	

<b>PART-TIME EMPLOYMENT</b>	<b>Best Buy, Rochester, NY</b>	<b>September 2011- Present</b>
	<b>Sales Associate</b>	
	Assist customers with electronic gaming purchases.	

**INTERESTS** Camping, tinkering with electronics, and antique auto restoration.

# MARY SMITH

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(585) 555-1234

**OBJECTIVE** To apply my knowledge of Microelectronic principles through co-op employment.  
Available late November 2012 through Late May 2013.

**EDUCATION** **ROCHESTER INSTITUTE OF TECHNOLOGY**, Rochester, NY  
Bachelor of Science, Microelectronic Engineering, expected May 2015  
GPA: 3.04/4.00

**COURSES**

Digital Systems	Circuit Analysis I & II
Semiconductor Devices I	IC technology
Engineering Math	Design of Experiments
Intro to Microlithography	Thin Films Processes
Linear Systems I	Electronics I
SiGe and SOI Devices	CMOS Electrical Circuit Design

**SKILLS** **Software:** Analog Workbench, C Programming, C++ Programming, Microsoft Office, Mathematica, JMP Athena, SUPREM  
**Hardware:** Tektronix Oscilloscope, Microscopes, Graphics Design, Digital Multimeter, Function Generator, GCA Stepper, Soldering Iron, Ion Implanter, X-ray, Instron Mechanical Tester

**EXPERIENCE** **ROCHESTER INSTITUTE OF TECHNOLOGY**, Rochester, NY  
**PC Technician, Wallace Library** November 2010 - present  
Assist computer users, manage computer labs, watch over print servers, create scripts and images for programs on computers, assist faculty and staff in need of assistance.

**PROJECTS/LABS** **Intro to Microlithography Lab**  
Learned the history of microlithography systems and processing steps which complement it. Learned how to use machines such as a GCA and spin stepper spin coater. Implemented use of high power microscopes to analyze wafers and gather measurements on overall distribution of thin film layers.

**IC Tech Lab**  
Applied an introduction to physics, chemistry, and materials for integrated circuits fabricated on a silicon lattice structure—primarily involving NMOS and PMOS junction devices. Experience includes knowledge of crystalline growth, oxidation steps with thermal processing, photolithographic processes, chemical vapor deposition, metallization, wafer doping by diffusion, ion implantation and virtual simulation using the SUPREM system.

**Thin Films Processes Lab**  
Lab focused on the deposition and etching of thin films of conductive and insulating materials for IC fabrication. A thorough overview of vacuum technology is presented to familiarize the challenges of creating and operating in a controlled environment. Chemical Vapor Deposition (CVD) and electroplating technologies are discussed as methods of film deposition. Plasma etching and Chemical Mechanical Planarization (CMP) are studied as methods for selective removal of materials.

**ACTIVITIES** Microelectronic Engineering Student Association: Member, 2010- present  
Woman Engineers at RIT: Member, 2010- present  
Traveling, rock climbing, modern dance.

# SUSAN SMITH

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Anytown, KS xxxxx  
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Rochester, NY 14xxx  
(xxx) xxx-xxxx

**OBJECTIVE** To obtain a co-op position in the Industrial Engineering field, and apply highly developed skills and knowledge. Available month, year to month, year.

**EDUCATION** **ROCHESTER INSTITUTE OF TECHNOLOGY**, Rochester, NY  
Bachelor of Science in Industrial and Systems Engineering, expected May 20xx  
GPA: 3.0/4.0

**Courses:**

Materials Processing with Lab	Computer Tools with Lab
Fundamentals of Industrial Engineering	Computing for Engineers with Lab
Materials Science with Lab	Mechanics I
Operations Research with Lab	Ergonomics with Lab
Engineering Management	Engineering Economy
Systems and Facilities Planning with Lab	Production Control

**SKILLS** **Software:** Microsoft Office, Microsoft Access, AMPL, VISUAL Manufacturing  
**Hardware:** Calipers, Micrometers, Lathe Machines, Horizontal and Vertical Milling Machines, Drill Presses

**PROJECTS/LABS** **Computer Tools Lab:** Used AutoCAD, and Microsoft Access to design parts that would be manufactured, and to create reports and queries to organize information  
**Operations Research Lab:** Used skills in linear programming and AMPL to solve large scale linear problems  
**Ergonomics Lab:** Performed labs based on the physiological and biomechanical aspects of human performance to develop skills in designing work places based on human capability  
**Systems and Facilities Planning Lab:** Built skills in material flow and material handling

**EXPERIENCE** **ENGINEERING CO-OP**  
**ABC Company, Small Town, MA** November 20xx - March 20xx  
-Implemented a system that improved the tracking of work orders on the manufacturing floor so that throughput can be assigned to a task once it is complete  
-Helped create and implement a new system to assign earned standard hours to work orders that are released  
-Reconfigured lead times of parts and orders in the system

**INDUSTRIAL ENGINEERING CO-OP**  
**123 Industries, Pleasantville, KY** March 20xx – August 20xx  
-Developed, updated and maintained cost effective job setups and planned time analysis  
-Gathered data for work measurement and assisted supervisors with planning and operations analysis  
-Completed Weekly Operational Review Audits  
-Created unload schedules for feeder trailer arrivals

**ACTIVITIES** **Society of Women Engineers** September 20xx – present  
Secretary – help organize meetings and events for group  
Mentor – assisted female high school juniors who visited campus for overnight program

**Big Brothers, Big Sisters, Volunteer**

**Hillside Children's Center, Volunteer**

# Wendy Turner

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390 Manson Road  
Rochester NY, 14623

## Objective

To obtain an internship or co-op that incorporates a technical position in Mechanical Engineering. Available from June 2012 through August 2012.

## Education

**Rochester Institute of Technology**, Rochester, NY  
Bachelor of Science in Mechanical Engineering, expected May 2014  
**GPA:** 3.05/4.0

## Courses

Fluid Mechanics  
Dynamics  
Materials Science

Mechanics of Materials  
Thermodynamics  
Statics

## Technical Skills

**Computer:** MS Office, ProEngineer, Labview, Matlab, Visual Basic, Image J, AutoCAD, SolidWorks, SAP

**Machine or fabrication:** Drill press, lathe, vertical mill

**Foreign Languages:** intermediate Spanish, intermediate Portuguese, beginning ASL, beginning German

## Projects/Labs

**Rube Goldberg Machine** – Designed and constructed a simplistic, cheap Rube Goldberg Machine for Imagine RIT.

**Northstar Summer Project** – Engineered an antenna that would be able to detect Sudden Ionospheric Disturbances in the atmosphere.

## Employment Experience

### **The Maytag Company**

**May 2011 – November 2011**

New Product Development Engineer

- Conducted temperature testing using type T & J thermocouples on power systems to determine T codes for UL and NEC standards.
- Collected data using DAQ National Instruments Hardware and Labview Software.
- Redesigned washer assemblies for optimization for expedited manufacturing insourcing for realized cost savings.
- Created drawing packages for manufacturing floor assemblies.

### **Rochester Institute of Technology – Rochester, New York**

**June 2010 – August 2010**

Researcher – Departments of Mechanical Engineering and Biology

- Tested stress and strains of cellular bonds in a flow chamber. Specifically worked with cancer cells.

### **Norwest Corporation – Kellogg, Iowa**

**July 2008 - December 2008**

Assistant to Secretary and Administration/Clerical Work

## Leadership/Community Service/Volunteering

### **Rochester Institute of Technology**

- Society of Hispanic Professional Engineers
  - President May 2010 – May 2011
  - Freshman Representative December 2010 – May 2010
- Diversity Leadership Advisory Board

**December 2010 - Present**

**November 2010 – May 2011**

# GABRIELLE DOUGLAS

1 Gold Medal Dr.  
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(585-555-2012)

1 ½ Park Point  
Rochester, NY 14623

<b>OBJECTIVE</b>	To apply my knowledge of Computer Engineering principles through co-op employment. Available June 2012 through November 2012.									
<b>EDUCATION</b>	<b>ROCHESTER INSTITUTE OF TECHNOLOGY</b> , Rochester, NY Bachelor of Science in Computer Engineering, expected May 2014 GPA: 4.00/4.00 Dean's List: Fall Quarters 2010, 2011  <b>Courses:</b> <table><tr><td>Digital Systems</td><td>Circuit Analysis I with Lab</td></tr><tr><td>Assembly Language with Lab</td><td>Circuit Analysis II</td></tr><tr><td>Hardware Description Language with Lab</td><td>Computer Organization</td></tr><tr><td>Computer Science 2-4</td><td>Software Engineering</td></tr></table>		Digital Systems	Circuit Analysis I with Lab	Assembly Language with Lab	Circuit Analysis II	Hardware Description Language with Lab	Computer Organization	Computer Science 2-4	Software Engineering
Digital Systems	Circuit Analysis I with Lab									
Assembly Language with Lab	Circuit Analysis II									
Hardware Description Language with Lab	Computer Organization									
Computer Science 2-4	Software Engineering									
<b>SKILLS</b>	<b>Languages:</b> C++, Java, VHDL, HCS12 Assembly, MIPS Assembly <b>Operating Systems:</b> Windows, Unix, Linux <b>Software:</b> Eclipse, PSpice, Altera Quartus, ModelSim, Capture CIS <b>Hardware:</b> Tektronix Oscilloscope, Digital Multimeter, Function Generator									
<b>PROJECTS/LABS</b>	<b>Digital Systems Lab</b> Various digital logic circuits were analyzed schematically and then tested on hardware using an Altera hardware board.  <b>Circuits I Lab</b> A basic resistor circuit, inverting op-amp, and RC circuit were analyzed schematically and then were built on a prototype board. Waveforms and voltages were measured and compared to the circuit.  <b>Software Engineering</b> Worked in a team with 5 others developing a Pizza Delivery System for a theoretical company using Java.									
<b>EXPERIENCE</b>	<b>Salsarita's @ RIT</b> , Rochester, NY Grill Cook/Food Server Cooked and served food for students, washed dishes.	Spring 2012  <b>Office of Co-op &amp; Career Services</b> , RIT Rochester, NY Student Assistant Answered phones, scheduled appointments, special projects as assigned by management and other staff members. June 2009 – September 2010								
<b>ACTIVITIES</b>	RIT Society of Women Engineers, President 2010 RIT Admissions Ambassador 2009 – Present RIT Ultimate Frisbee Team 2009 – Present									
<b>INTERESTS</b>	Gymnastics, gourmet cooking, traveling									

# Timothy Cooke

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845-644-9963

## Objective:

Seeking full time employment in the field of product development, available summer 2011

## Education:

### Rochester Institute of Technology

Rochester, NY

Bachelor of Science in Mechanical Engineering with Energy & Environment Option, Expected May 2011  
GPA 3.0

## Relevant Courses:

Engineering Design Graphics

Design of Machine Elements

Robotics

Materials Processing with Fabrication Lab

Mechanics of Materials with Lab

Measurement Instrumentation and Controls Lab

## Skills:

**Software:** Pro E, Solid Works, AutoCAD, Visual Basic, PBASIC, LabView, Matlab, Office (Excel, PP, etc.)

**Leadership:** Experienced leader in project based group work

**Communication:** Experienced in professional day to day oral and written interaction with diverse groups of people from around the world

## Projects:

**Multidisciplinary Senior Design:** Required to design and fabricate a portable, low cost, 100W micro hydro turbine for third world countries and those without access to electricity. The team consists of four engineers; I serve as the lead engineer and am primarily responsible for fluid mechanics analysis and FEA of the system. The desired outcome is an economic and sustainable way to produce and store electricity in a 12V battery for those who do not have access to electricity.

**Robotics:** Team leader in design, construction, and programming of a small box stacking A.I. robot

**Alternative Energy:** Team based design of scholastic bio-diesel fuel generation process. The concept won a class based competition. Grade received: A

**ProE Vice Project:** The objective was to create a twenty seven part vice with 3D ProE software.

Each part of the vice was designed in ProE and then cataloged and researched for prices and availability. The final product resulted in a professional assembly drawing and bill of materials. Grade received: A

## Work Experience:

Bose Corporation, Framingham, MA

March 2010 - November 2010

### Transducer Technology Corporate Research and Development Co-op

Served as part of a multidisciplinary team that conducted research on suspensions in audio transducers. Primarily responsible for the fabrication and characterization of the performance of these suspensions and reporting the results to the team. Work involved significant design and execution of experiments.

Advance Testing Company, Inc., Campbell Hall, NY

August 2009 - November 2009

### Engineering Field Technician

Completed on site asphalt density tests with nuclear density gauge.

**Certifications:** 10 Hour OSHA Safety Training Certification, Nuclear Density Inspector Certification

## Volunteer Work:

Albany Equinox Charity Thanksgiving Dinner 2008

Helped prepare and distribute foods for city charity dinner

## Activities and Interests:

Club soccer, working on ATVs/vehicles, club softball, rock climbing, skiing, golf, hiking, innovation, technology, traveling, reading, and lifelong learning